Panasonic

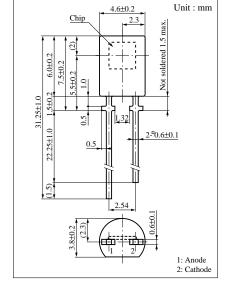
PNZ323 (PN323)

PIN Photodiode

For optical control systems

Features

- Fast response which is well suited to high speed modulated light detection: t_r, t_f = 50 ns (typ.)
- High sensitivity, high reliability
- Peak sensitivity wavelength matched with infrared light emitting diodes: $\lambda_P = 900 \text{ nm}$ (typ.)
- Wide detection area, wide acceptance half angle : $\theta = 70$ deg. (typ.)
- Adoption of visible light cutoff resin



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

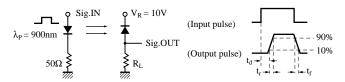
Parameter	Symbol	Ratings	Unit
Reverse voltage (DC)	V_R	30	V
Power dissipation	P_{D}	100	mW
Operating ambient temperature	Topr	-30 to +85	°C
Storage temperature	T _{stg}	-40 to +100	°C

■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Dark current	I_{D}	$V_R = 10V$		5	50	nA
Photo current	I_L	$V_R = 10V, L = 1000 lx^{*1}$		55		μΑ
Sensitivity to infrared emitters	S _{IR} *2	$V_R = 5V, H = 0.1 \text{mW/cm}^2$	4.5	6		μΑ
Peak sensitivity wavelength	λ_{P}	$V_R = 10V$		900		nm
Response time	t_r, t_f^{*3}	$V_R = 10V, R_L = 1k\Omega$		50		ns
Response time	t _r , t _f *3	$V_R = 10V, R_L = 100k\Omega$		5		μs
Capacitance between pins	C _t	$V_R = 0V, f = 1MHz$		70		pF
Acceptance half angle	θ	Measured from the optical axis to the half power point		70		deg.

 $^{^{*1}}$ Measurements were made using a tungsten lamp (color temperature T = 2856K) as a light source.

^{*3} Switching time measurement circuit

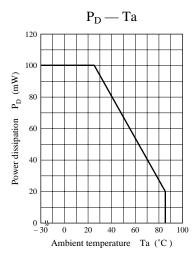


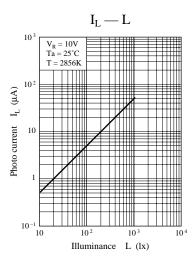
- t_d: Delay time
- t_r: Rise time (Time required for the collector photo current to increase from 10% to 90% of its final value)
- $t_{\rm f}$: Fall time (Time required for the collector photo current to decrease from 90% to 10% of its initial value)

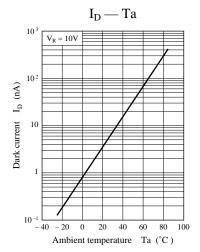
Note) The part number in the parenthesis shows conventional part number.

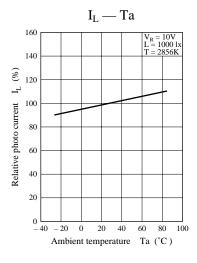
^{*2} Light source : $\lambda = 940 \text{ nm}$

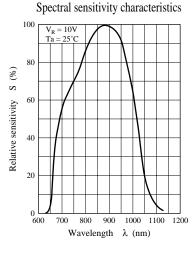
PIN Photodiodes PNZ323

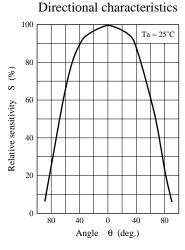


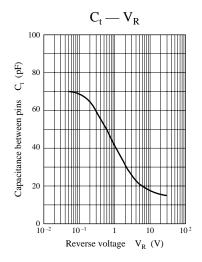


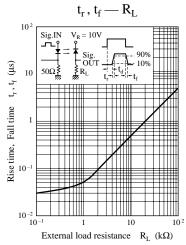


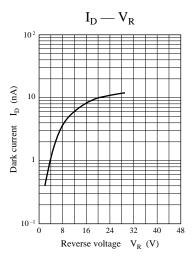












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